Serial No.: 10/565,429

Filing Date: January 18, 2006

Customer No.: 26,289 Attorney's Docket No.: 2003JP317

Complete set of Claims

[1] (previously amended) A coating composition comprising: a polyalkylsilazane compound; an acetoxysilane compound; and an organic solvent.

[2] (original) The coating composition according to claim 1, which further comprises a pore forming agent.

- [3] (original) The coating composition according to claim 2, wherein said pore forming agent is a copolymer comprising a siloxy-containing polyethylene oxide compound or a siloxy-containing polyethylene oxide compound as monomer units.
- [4] (previously amended) The coating composition according to claim 1, wherein said polyalkylsilazane compound comprises repeating units represented by general formula (1):

[Chemical formula 1]

$$\begin{bmatrix}
\begin{pmatrix}
R^2 \\
N
\end{pmatrix}_{p} & R^1 \\
S_{i} & N \\
N-R^3
\end{pmatrix}_{q}$$
(1)

wherein R¹ represents a hydrogen atom or an alkyl group having 1 to 3 carbon atoms, provided that all of R¹s of the whole compound do not simultaneously represent hydrogen;

 R^2 to R^4 each independently represent a hydrogen atom or an alkyl group having 1 to 3 carbon atoms, provided that all of R^2 to R^4 do not simultaneously represent hydrogen; and

p, q, and r each are 0 or 1 and $0 \le p + q + r \le 3$.

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[5] (previously amended) A siliceous material produced by coating a coating composition according to claim 1 onto a substrate or by filling a coating composition according to any one of claims 1 to 4 into a frame or a groove, and firing the coating composition.

- [6] (previously amended) A semiconductor device comprising a siliceous material according to claim 5 as an intermetal dielectric.
- [7] (previously amended) A process for producing a siliceous material, comprising heating a coating composition according to claim 1 at a temperature of 350°C or below for 1 to 60 min.
- [8] (previously presented) The coating composition according to claim 1, wherein said polyalkylsilazane compound further contains one or both groups represented by formulae (2) and (3)

$$\frac{\begin{pmatrix}
R^5 \\
Si - N \\
R^6 & R^7
\end{pmatrix}$$
(2)

$$\frac{\begin{pmatrix}
R^8 & R^9 \\
-\begin{pmatrix}
N - S_1 - R^{10}
\end{pmatrix}$$
(3)

wherein R^5 to R^{11} each independently represent a hydrogen atom or an alkyl group having 1 to 3 carbon atoms, provided that both R^5 and R^6 do not simultaneously represent hydrogen and all of R^9 to R^{11} do not simultaneously represent hydrogen.

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[9] (new) The coating composition according to claim 1, where the acetoxysilane is selected from tetraacetoxysilane, methyltriacetoxysilane, ethyltriacetoxysilane, ethoxytriacetoxysilane, isopropoxytriacetoxysilane, n-butoxytriacetoxysilane, dimethyldiacetoxysilane, diethyldiacetoxysilane, diethyldiacetoxysilane, dimethoxydiacetoxysilane, diethoxyacetoxysilane, diisopropoxydiacetoxysilane, and di-n-butoxydiacetoxysilane.